

## COMBINED DECLARATION AND POWER OF ATTORNEY

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

### THIN FILM TRANSISTOR AND MANUFACTURING METHOD THEREOF

the specification of which

X is attached hereto.

was filed on \_\_\_\_\_

as Application Serial No. \_\_\_\_\_ and was amended on \_\_\_\_\_.

I hereby state that I have reviewed and understood the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

### Not Applicable

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application:

**U.S. Patent Application Ser. No. 10/777,564, filed on February 11, 2004.**

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

**Belinda Lee**

**(Reg. No. 46,863)**

**Charles Liu**

**(Reg. No. 53,226)**

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SEND CORRESPONDENCE TO:

DIRECT TELEPHONE CALLS TO:

(Name and Telephone Number)

JIANQ CHYUN Intellectual Property Office

7F.-1, No. 100, Roosevelt Rd., Sec. 2,

Taipei 100, Taiwan, R.O.C.

TEL: 886-2-2369 2800

FAX: 886-2-2369 7233


E-mail: [Belinda@JCIPGroup.com.tw](mailto:Belinda@JCIPGroup.com.tw) ; [USA@JCIPGroup.com.tw](mailto:USA@JCIPGroup.com.tw)

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**Belinda Lee**

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature: 

Date: 8/6/04

Sole or First Joint Inventor: Fang-Chen Luo

Citizenship: Taiwan, R.O.C.

Residence and Post Office Address: 7F., No. 2-2, Chu-Tsun 7 Rd., Ke-Yuan Li, Hsinchu, Taiwan,  
R.O.C.

Signature: Wan-Yi Liu

Date: July 30, 2004

Second Joint Inventor (if any): Wan-Yi Liu

Citizenship: Taiwan, R.O.C.

Residence and Post Office Address: 14F.-1, No.123-1, Lane 89, Sec. 1, Guangfu Rd., Hsinchu City  
300, Taiwan, R.O.C.

Signature: Chieh-Chou Hsu

Date: July 30, 2004

Third Joint Inventor (if any): Chieh-Chou Hsu

Citizenship: Taiwan, R.O.C.

Residence and Post Office Address: No.6, Lane 214, Rueising St., Cianjhen District, Kaohsiung City  
806, Taiwan, R.O.C.